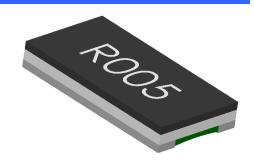
# **RLM-1632W-6F Series Current Sensor Resistor (Lead / Halogen Free)**

## **Features / Applications:**

- Power rating is up to 1W
- Low TCR current sensor
- Low thermal EMF (< 3 µV/°C)
- Resistors are ideal for all types of current sensing
- Metal foil construction; Excellent long-term stability
- Moisture sensitivity level: MSL 1
- RoHS compliant

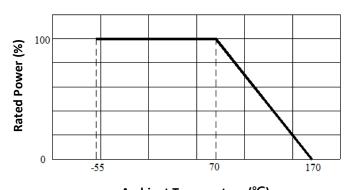


## **Electrical Specifications:**

Characteristics <sup>1</sup>		Feature	
Power Rating <sup>2</sup>	1 W		
Resistance Value(mΩ)	1 \ 1.5	2 \ 2.5	3 to 10
Temperature Coefficient of Resistance(ppm/°C)	± 200	± 150	± 100
Operation Temperature Range	-55°C to +170°C		
Maximum Working Voltage (V)	( P*R) <sup>1/2</sup>		

### Note:

- 1. For detailed information see table on page 3
- 2. For sensors operated at ambient temperature in excess of 70°C, the maximum load shall be derated in accordance with the following curve.



Ambient Temperature (°C)

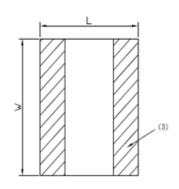
Figure 1. : Power Temperature Derating Curve

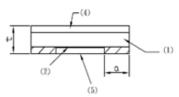
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## **Outline Drawing:**

### Dimensions and schematic:





- (1) Substrate
- (2) Resistor : Cu alloy(3) Terminals: Sn (on Cu )
- (4) Protection coat:

Heat resistive epoxy resin (Black)

(5) Protection coat:

Heat resistive epoxy resin (White)

Resistance Range(mΩ)	L	W	а	t
1 \ 1.5	1.60±0.20	2 20 + 0 25	0.35 ± 0.20	0.70± 0.20
2 to 10		3.20 ± 0.25		0.50± 0.20

(Unit:mm)

## **Type Designation:**

R L M - 1 6 3 2 W - 6F - \_ NH

- (1) (2) (3) (4)
- Note:
- (1) Series No.
- (2) Size
- (3) Power Rating :6F = 1W
- (4) Resistance value :  $0R5m = 0.5m\Omega$  ;  $R001 = 1m\Omega$  ;  $R010 = 10m\Omega$

(5)

(5) Tolerance: ±1%(F), ±2%(G)

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## **Available standard resistance values:**

Resistance Values	Tolerance		
	±1.0%	±2.0%	
R001	✓	✓	
1R5m	✓	✓	
R002	✓	✓	
2R5m	✓	✓	
R003	✓	✓	
R004	✓	✓	
4R5m	✓	✓	
R005	✓	✓	
R006	✓	✓	
R007	✓	✓	
R008	✓	✓	
R009	✓	✓	
R010	<b>√</b>	✓	

✓ = available

Further values and tolerances on request.

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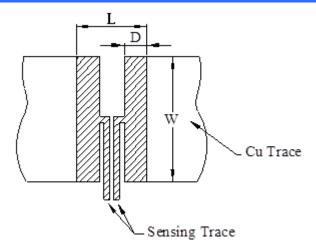
## **Reliability Performance:**

Test Item	Condition of Test	Requirements
Short Time Overload	2.5 x Rated power for 5 seconds Refer to JIS C 5201-1 4.13	ΔR: ± 1.0%
Thermal Cycling	-55 to 125℃ 100 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	ΔR: ±1.0%
Low Temperature Storage	Kept at -55℃, 1000 hours Refer to JIS C 5201-1 4.23.4	ΔR : ± 2.0%
Resistance to Soldering Heat	Dipped into solder at $270 \pm 5^{\circ}$ C for $10 \pm 1$ seconds Refer to JIS C 5201-1 4.18	ΔR: ±1.0%
Load Life	Rated voltage for 1.5hours followed by a pause 0.5hour at 70 ± 3°C Cycle repeated 1000 hours Refer to JIS C 5201-1 4.25	ΔR: ± 2.0%
Damp Heat with Load	40 ± 2°C with relative humidity 90% to 95%. D.C. rated voltage for 1.5 hours ON and 30 minutes OFF. Cycle repeated 1000 hours Refer to JIS C 5201-1 4.24	ΔR: ± 2.0%
High Temperature Exposure	Kept at 170°C for 1000 hours Refer to JIS C 5201-1 4.23.2	ΔR: ± 2.0%
Solderability	Temperature of Solder : $245 \pm 5^{\circ}$ C Immersion Duration : $3 \pm 0.5$ second Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed
Mechanical Shock	100 G's for 6milliseconds. 5 pulses Refer to JIS C 5201-1 4.21	ΔR : ± 1.0%
Substrate Bending	Glass-Epoxy board thickness : 1.6mm Bending width : 2mm Between the fulcrums : 90mm Refer to JIS C 5201-1 4.33	ΔR: ±1.0%

Note: Measurement at 24±4 hours after test conclusion for all reliability tests-parts.

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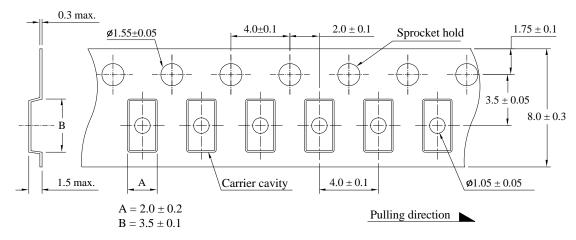
## **Recommend Solder Pad Dimensions:**



Dimensions (mm)	w	L	D
1 to 10 mΩ	3.5	2.4	0.9

## Packaging:

### Tape packaging dimensions:



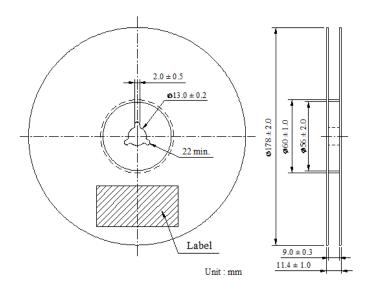
Unit: mm

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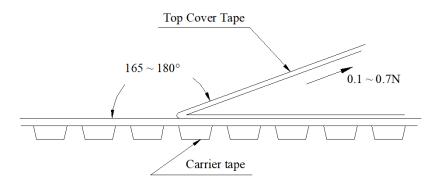
### Reel dimensions:



### Peel Strength of Top Cover Tape:

The peel speed shall be about 300mm/min.

The peel force of top cover tape shall between 0.1 to 0.7N



### Number of Taping:

4,000 pieces / reel

### **Label Marking:**

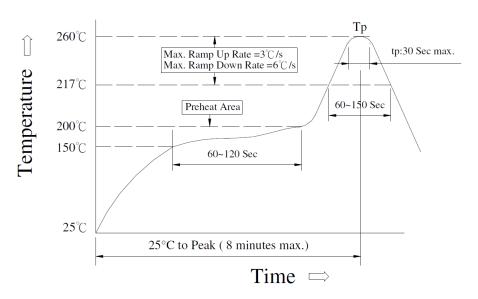
The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin

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## **Recommend Soldering Conditions:**



### Meet JEDEC-020D

### (1) Reflow Soldering Method:

Reflow Soldering	Tp:255 to 260°C Max.30 seconds ( Tp )	
	217°C 60 to 150 seconds	
Pre-Heat	150 to 200℃ 60 to 120 seconds	
Time 25℃ to peak temperature	8 minutes max	

(2) Soldering Iron Method: 350± 5°C max.3 seconds

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### **Care Note:**

#### Care note for storage

- (1) Current sensor shall be stored in a environment where temperature and humidity must be controlled (temperature 5 to 40°C, humidity 30 to 80% RH). However, the humidity should be maintained as low as possible.
- (2) Current sensor shall not be stored under direct sunlight.
- (3) Current sensor shall be stored in condition without moisture, dust, any material defect solderability, or hazardous gas (i.e. Chlorination hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- (4) The sensor can be stored for at least one year under the condition mentioned above.

#### Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.

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